| FORM PTO-1449   | Atty. Docket No.: s01.12-0992 | Appl. No.: |  |  |
|---|-------------------------------|------------|--|--|
| LIST OF PATENTS AND PUBLICATIONS FOR<br>APPLICANT'S INFORMATION<br>DISCLOSURE STATEMENT | First Named Inventor:         |            |  |  |
|   | Zine-Eddine Bouta             | agnou      |  |  |
|   | Filing Date                   | Group Art: |  |  |
| _   | HEREWITH                      | 2652       |  |  |

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